Field Stop Trench IGBT

40 A, 650 V

AFGHL40T65SQD

Using the novel field stop 4th generation high speed IGBT technology. AFGHL40T65SQD which is AEC Q101 qualified offers the optimum performance for both hard and soft switching topology in automotive application.

Features

- AEC-Q101 Qualified
- Maximum Junction Temperature: $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(Sat)} = 1.6 \text{ V} (Typ.) @ I_C = 40 \text{ A}$
- 100% of the Parts are Tested for I_{LM} (Note 2)
- Fast Switching
- Tight Parameter Distribution
- RoHS Compliant

Typical Applications

- Automotive HEV-EV Onboard Chargers
- Automotive HEV-EV DC-DC Converters
- Totem Pole Bridgeless PFC
- PTC

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-to-Emitter Voltage	V _{CES}	650	V
Gate-to-Emitter Voltage Transient Gate-to-Emitter Voltage	V _{GES}	±20 ±30	V
$ \begin{array}{c} \mbox{Collector Current (Note 1)} & @\ T_C = 25^\circ C \\ & @\ T_C = 100^\circ C \end{array} $	Ι _C	80 40	A
Pulsed Collector Current (Note 2)	I _{LM}	160	А
Pulsed Collector Current (Note 3)	I _{CM}	160	А
	١ _F	80 20	A
Pulsed Diode Maximum Forward Current	I _{FM(2)}	160	А
$ \begin{array}{ll} \mbox{Maximum Power Dissipation} & @\ T_C = 25^\circ C \\ & @\ T_C = 100^\circ C \end{array} $	P _D	238 119	W
Operating Junction / Storage Temperature Range	T _J , T _{STG}	–55 to +175	°C
Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5 seconds	ΤL	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

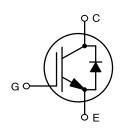
- 1. Value limit by bond wire
- 2. V_{CC} = 400 V, V_{GE} = 15 V, I_C = 160 A, R_G = 15 Ω , Inductive Load
- 3. Repetitive Rating: pulse width limited by max. Junction temperature



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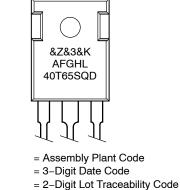
www.onsemi.com

40 A, 650 V, V_{CESat} = 1.6 V





MARKING DIAGRAM



&K = 2–Digit Lot Traceability Co AFGHL40T65SQD = Specific Device Code

&Z

&З

ORDERING INFORMATION

Device	Package	Shipping
AFGHL40T65SQD	TO-247-3L	30 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ hetaJC}$	0.63	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ hetaJC}$	1.71	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

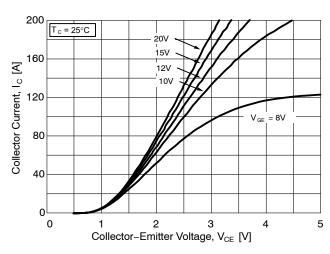
Parameter Test Conditions		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE} = 0 V,$ $I_{C} = 1 mA$	BV _{CES}	650	-	-	V
Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	ΔBV _{CES} ΔTJ	-	0.6	-	V/°C
Collector-emitter cut-off current, gate-emitter short-circuited	V _{GE} = 0 V, V _{CE} = 650 V	I _{CES}	_	-	250	μΑ
Gate leakage current, collector- emitter short-circuited	V _{GE} = 20 V, V _{CE} = 0 V	I _{GES}	_	-	±400	nA
ON CHARACTERISTICS				•		4
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$, $I_C = 40 \text{ mA}$	V _{GE(th)}	3.4	4.9	6.4	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 40 A V _{GE} = 15 V, I _C = 40 A, T _J = 175°C	V _{CE(sat)}	-	1.6 1.95	2.1 -	V
DYNAMIC CHARACTERISTICS				4		
Input capacitance	V _{CE} = 30 V,	Cies	-	2339	-	pF
Output capacitance	V _{GE} = 0 V, f = 1 MHz	C _{oes}	-	61	-	
Reverse transfer capacitance		C _{res}	-	8	-	
Gate charge total	V _{CE} = 400 V,	Qg	-	68	-	nC
Gate-to-emitter charge	I _C = 40 A, V _{GE} = 15 V	Q _{ge}	-	13	-	
Gate-to-collector charge		Q _{gc}	-	16	-	
SWITCHING CHARACTERISTICS, IND	UCTIVE LOAD					
Turn-on delay time	$T_{\rm C} = 25^{\circ}{\rm C},$	t _{d(on)}	-	15	-	ns
Rise time	V _{CC} = 400 V, I _C = 20 A,	t _r	-	10	-	1
Turn-off delay time	R _G = 6 Ω, V _{GE} = 15 V,	t _{d(off)}	-	70	-	
Fall time	Inductive Load	t _f	_	3	-	
Turn-on switching loss		E _{on}	_	0.25	-	mJ
Turn-off switching loss		E _{off}	-	0.09	-	1
Total switching loss		E _{ts}	-	0.34	-	
Turn-on delay time	$T_{\rm C} = 25^{\circ}{\rm C},$	t _{d(on)}	-	17	-	ns
Rise time	V _{CC} = 400 V, I _C = 40 A,	t _r	-	22	-	
Turn-off delay time	$\overrightarrow{R}_{G} = 6 \Omega,$ $V_{GE} = 15 V,$	t _{d(off)}	-	67	-	
Fall time	Inductive Load	t _f	-	31	-	
Turn-on switching loss		E _{on}	-	0.75	-	mJ
Turn-off switching loss		E _{off}	-	0.29	-	
Total switching loss	1	E _{ts}	_	1.04	_	1

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted) (Continued)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS, IN	DUCTIVE LOAD					
Turn-on delay time	T _C = 175°C,	t _{d(on)}	-	14	-	ns
Rise time	V _{CC} = 400 V, I _C = 20 A,	t _r	-	12	-	
Turn-off delay time	R _G = 6 Ω, V _{GE} = 15 V,	t _{d(off)}	-	81	-	
Fall time	Inductive Load	t _f	-	7	-	
Turn-on switching loss		E _{on}	-	0.46	-	mJ
Turn-off switching loss		E _{off}	-	0.22	-	
Total switching loss		E _{ts}	-	0.68	-	
Turn-on delay time	T _C = 175°C,	t _{d(on)}	-	16	-	ns
Rise time	V _{CC} = 400 V, I _C = 40 A,	t _r	-	25	-	
Turn-off delay time	R _G = 6 Ω, V _{GE} = 15 V,	t _{d(off)}	-	75	-	
Fall time	Inductive Load	t _f	-	38	-	
Turn-on switching loss		E _{on}	-	1.06	-	mJ
Turn-off switching loss	-	E _{off}	-	0.47	-	
Total switching loss	-	E _{ts}	-	1.53	-	
DIODE CHARACTERISTICS						
Diode Forward Voltage	I _F = 20 A, T _C = 25°C	V _{FM}	-	2.0	2.6	V
	I _F = 20 A, T _C = 175°C		-	1.75	-	1
Reverse Recovery Energy	$I_{F} = 20 \text{ A, } dI_{F}/dt = 200 \text{ A}/\mu\text{s}, \\ T_{C} = 175^{\circ}\text{C}$	E _{rec}	_	54	-	μJ
Diode Reverse Recovery Time	$I_F = 20 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, \\ T_C = 25^\circ\text{C}$	T _{rr}	_	28	-	ns
	$I_{F}=20 \text{ A, } dI_{F}/dt=200 \text{ A}/\mu\text{s}, \\ T_{C}=175^{\circ}\text{C}$	T _{rr}	_	209	-	
Diode Reverse Recovery Charge	$I_F = 20 \text{ A, } dI_F/dt = 200 \text{ A}/\mu\text{s}, \\ T_C = 25^\circ\text{C}$	Q _{rr}	-	38	-	nC
	$I_{F} = 20 \text{ A}, \text{ dI}_{F}/\text{dt} = 200 \text{ A}/\mu\text{s}, \\ T_{C} = 175^{\circ}\text{C}$	Q _{rr}	-	605	-	1

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS





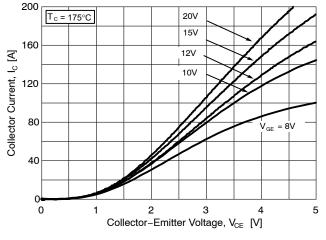
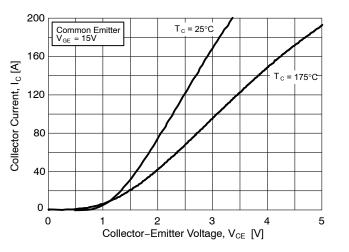
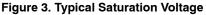


Figure 2. Typical Output Characteristics





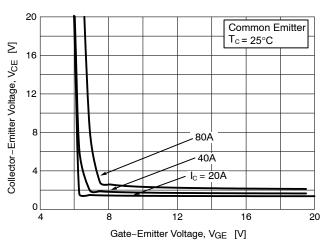


Figure 5. Saturation Voltage vs. V_{GE}

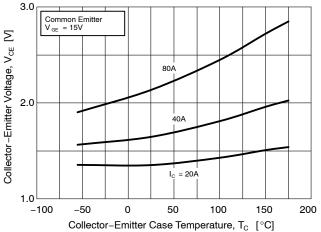


Figure 4. Saturation Voltage vs. Case Temperature

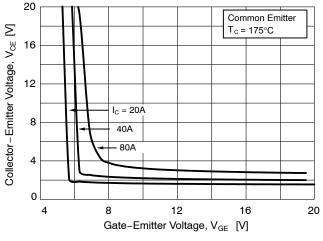
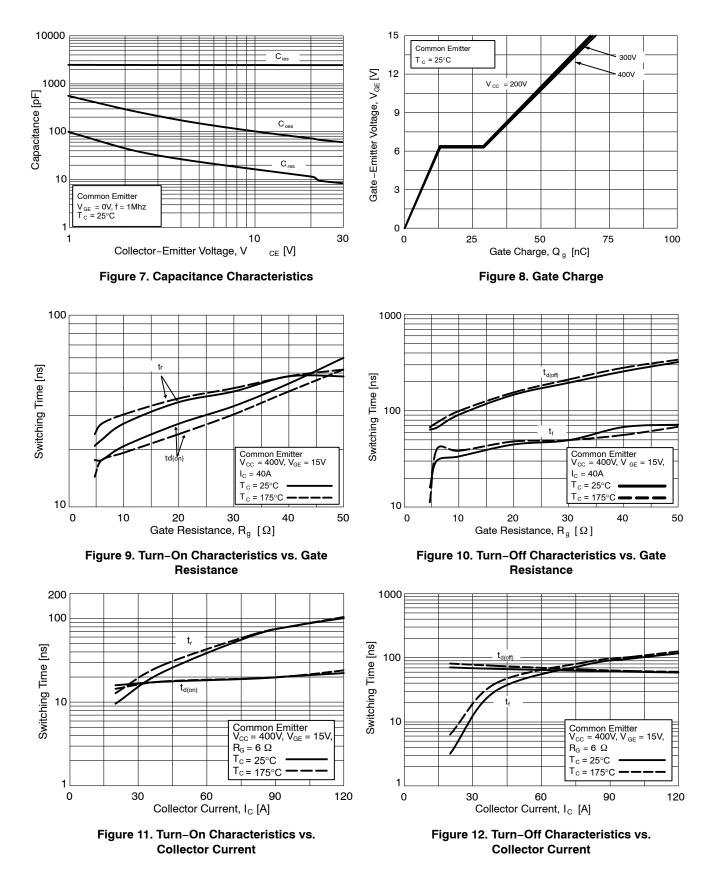
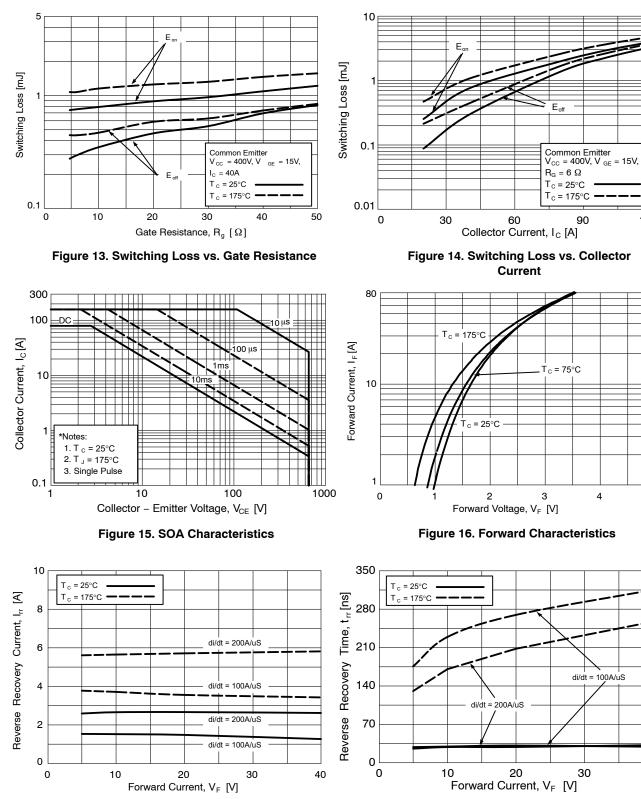


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS







120

5

40

TYPICAL CHARACTERISTICS

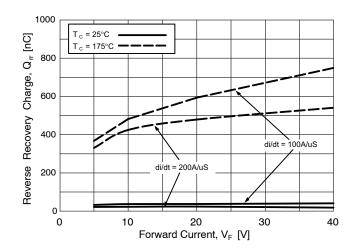
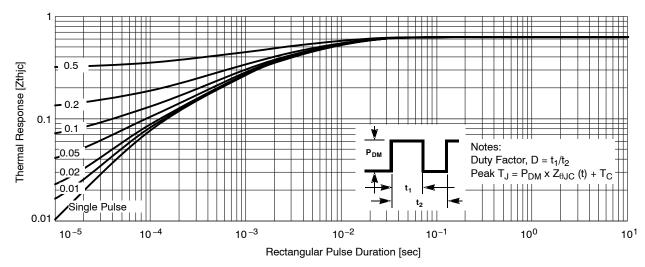


Figure 19. Stored Charge





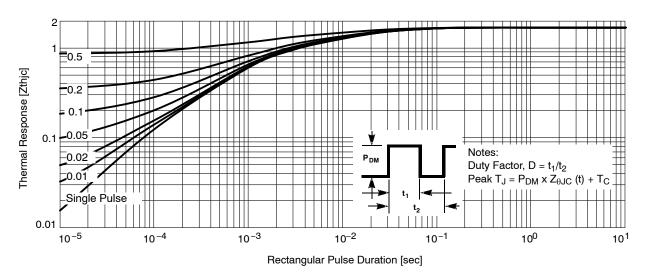
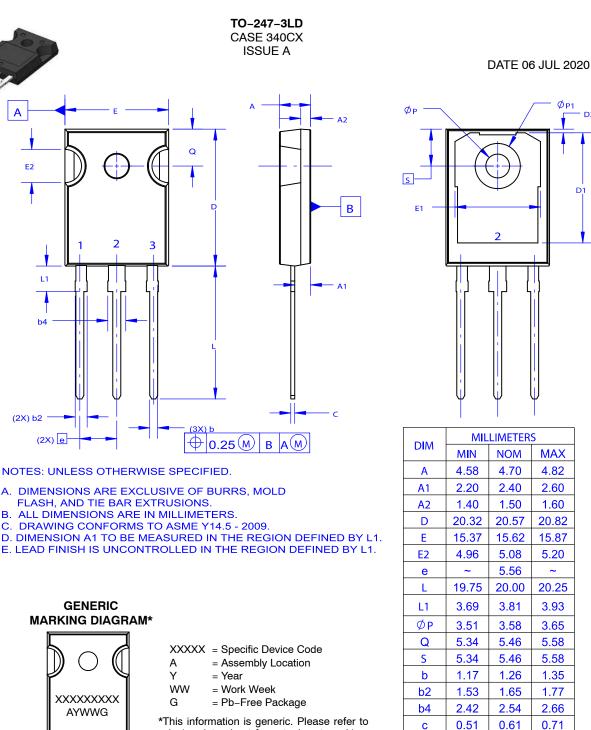


Figure 21. Transient Thermal Impedance of Diode



*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

С

D1

D2

E1

Ø P1

13.08

0.51

12.81

6.60

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0.93

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6.80

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